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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Sheet

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of

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Complete if Known

Application Number	10/682.651
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Filing Date	October 9, 2003
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First Named Inventor	William S. DiPoala
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Art Unit	283
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Examiner Name

Attorney Docket Number	BSS0010
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U. S. PATENT DOCUMENTS

Examiner Initials*	Cite No. ¹	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number-Kind Code ² (if known)			
HVN		US- 6,377,473	04-23-2002	Huang et al.	
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Signature**

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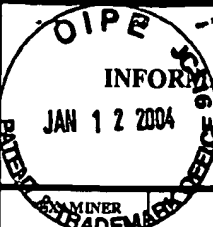
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 <p>INFORMATION DISCLOSURE CITATION (Use several sheets if necessary)</p>		Docket Number (Optional) BSS0010		Application Number 10/682,651	
		Applicant(s) William S. DiPoala			
		Filing Date October 9, 2003		Group Art Unit	
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✗					
EXAMINER HVN		DATE CONSIDERED 09-30-05			
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